

## NEC

# MOS FIELD EFFECT TRANSISTORS **2SK2365/2SK2366**

#### SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

#### DESCRIPTION

The 2SK2365, 2SK2365-Z/2SK2366, 2SK2366-Z is N-Channel MOS Field Effect Transistor designed for high voltage switching applications.

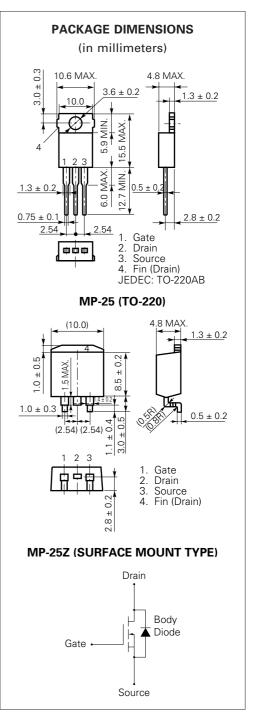
#### **FEATURES**

- Low On-Resistance
  2SK2365: R<sub>DS(on)</sub> = 0.5 Ω (V<sub>GS</sub> = 10 V, I<sub>D</sub> = 5.0 A)
  2SK2366: R<sub>DS(on)</sub> = 0.6 Ω (V<sub>GS</sub> = 10 V, I<sub>D</sub> = 5.0 A)
- Low Ciss Ciss = 1 600 pF TYP.
- High Avalanche Capability Ratings
- Isolate TO-220 Package

#### ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

Drain to Source Voltage (2SK2365/2SK2366)	VDSS	450/500	V
Gate to Source Voltage	Vgss	±30	V
Drain Current (DC)	D(DC)	±10	А
Drain Current (pulse)*	D(pulse)	±40	А
Total Power Dissipation (T <sub>c</sub> = 25 $^{\circ}$ C)	<b>P</b> T1	75	W
Total Power Dissipation (T <sub>A</sub> = 25 $^{\circ}$ C)	Рт2	1.5	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg -	-55 to +150	°C
Single Avalanche Current**	las	10	А
Single Avalanche Energy**	Eas	143	mJ
* PW $\leq$ 10 $\mu$ s, Duty Cycle $\leq$ 1 %			

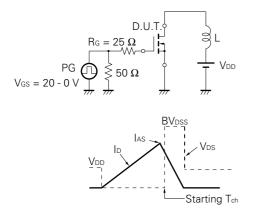
\*\* Starting T<sub>ch</sub> = 25 °C, R<sub>G</sub> = 25  $\Omega$ , V<sub>GS</sub> = 20 V  $\rightarrow$  0



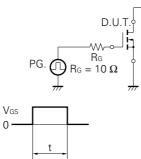
#### ELECTRICAL CHARACTERISTICS (TA = 25 °C)

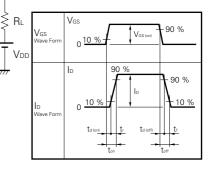
CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS	
Drain to Source On-State Resistance	RDS(on)		0.4	0.5	Ω	$V_{GS} = 10 V$	2SK2365
			0.5	0.6		ID = 5.0 A	2SK2366
Gate to Source Cutoff Voltage	V <sub>GS(off)</sub>	2.5		3.5	V	Vds = 10 V, Id = 1 mA	
Forward Transfer Admittance	y <sub>fs</sub>	4.0			S	$V_{\text{DS}}$ = 10 V, $I_{\text{D}}$ = 5.0 A	
Drain Leakage Current	Ibss			100	μA	$V_{DS} = V_{DSS}, V_{GS} = 0$	
Gate to Source Leakage Current	lgss			±100	nA	$V_{GS} = \pm 30 \text{ V}, \text{ V}_{DS} = 0$	
Input Capacitance	Ciss		1 600		pF	$V_{\text{DS}} = 10 \text{ V}$	
Output Capacitance	Coss		310		pF	Vgs = 0	
Reverse Transfer Capacitance	Crss		30		pF	f = 1 MHz	
Turn-On Delay Time	td(on)		30		ns	ID = 5.0 A	
Rise Time	tr		20		ns	$V_{GS} = 10 V$	
Turn-Off Delay Time	td(off)		80		ns	Vdd = 150 V	
Fall Time	tr		20		ns	$R_{G} = 10 \ \Omega \ R_{L}$	= 30 Ω
Total Gate Charge	Q <sub>G</sub>		42		nC	ID = 10 A	
Gate to Source Charge	Qgs		10		nC	$V_{DD} = 400 V$	
Gate to Drain Charge	Qgd		20		nC	Vgs = 10 V	
Body Diode Forward Voltage	VF(S-D)		1.0		V	IF = 10 A, VGS	= 0
Reverse Recovery Time	trr		350		ns	IF = 10 A, VGS	= 0
Reverse Recovery Charge	Qrr		1.5		μC	di/dt = 50 A/µs	3

#### Test Circuit 1 Avalanche Capability

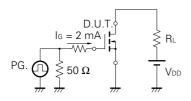


#### Test Circuit 2 Switching Time





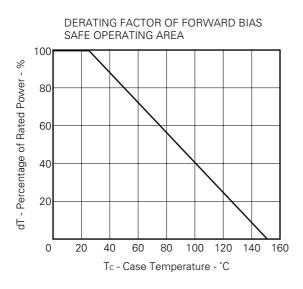
#### Test Circuit 3 Gate Charge



The application circuits and their parameters are for references only and are not intended for use in actual design-in's.

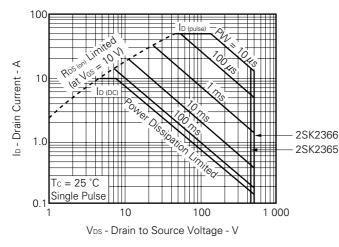
t = 1us

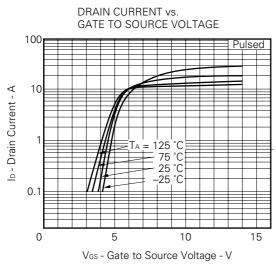
Duty Cycle ≤ 1 %

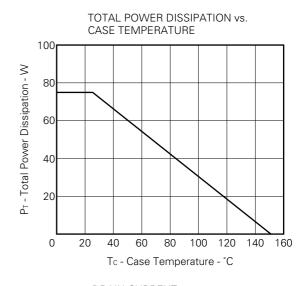


#### TYPICAL CHARACTERISTICS (TA = 25 °C)

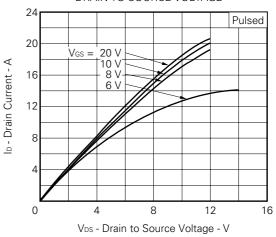


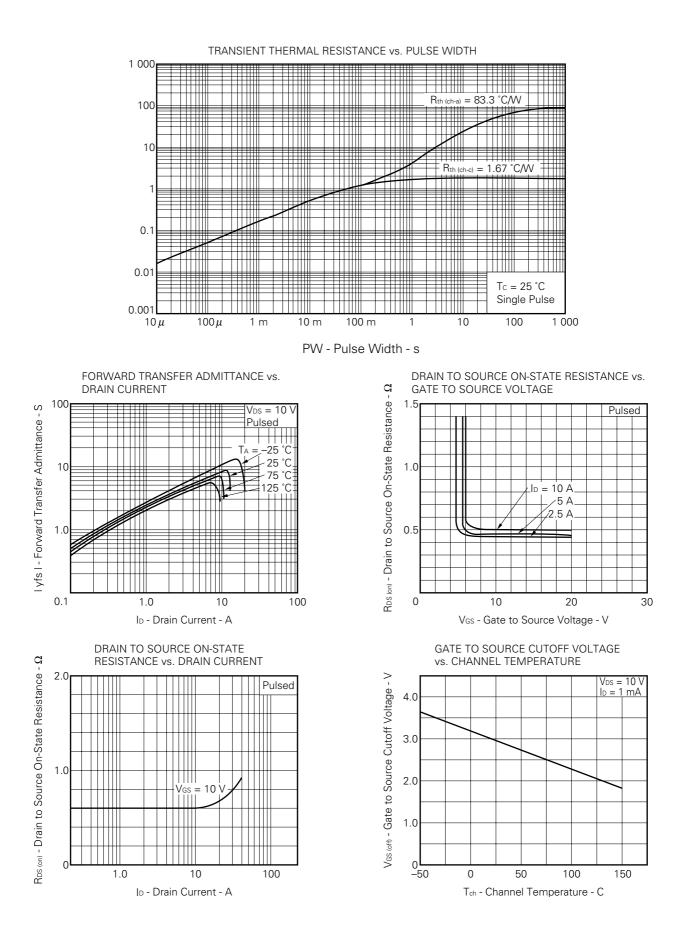




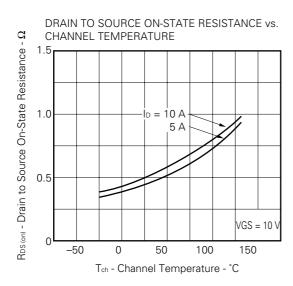


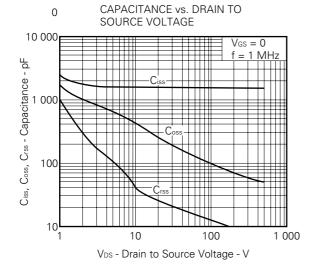
DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE

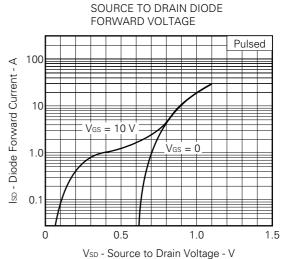




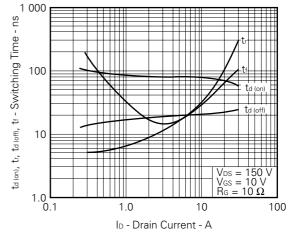


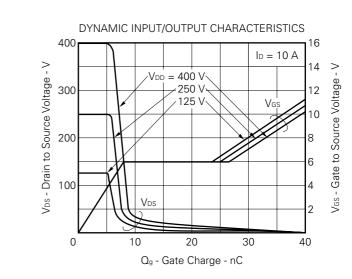


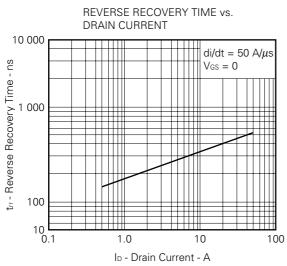






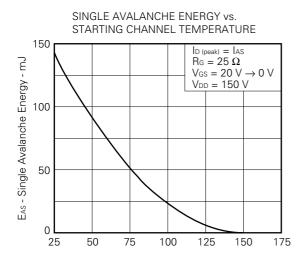


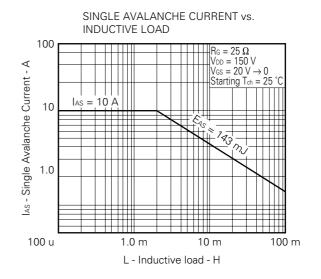




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#### REFERENCE

Document Name	Document No.
NEC semiconductor device reliability/quality control system.	TEI-1202
Quality grade on NEC semiconductor devices.	IEI-1209
Semiconductor device mounting technology manual.	IEI-1207
Semiconductor device package manual.	IEI-1213
Guide to quality assurance for semiconductor devices.	MEI-1202
Semiconductor selection guide.	MF-1134
Power MOS FET features and application switching power supply.	TEA-1034
Application circuits using Power MOS FET.	TEA-1035
Safe operating area of Power MOS FET.	TEA-1037

The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device is actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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Anti-radioactive design is not implemented in this product.

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